

# SEMIPACK® 1

## Fast Thyristor/ Diode Modules

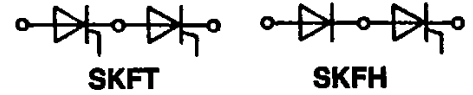
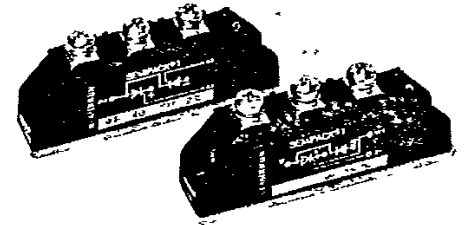
**SKFT 40**  
**SKFT 60**

**SKFH 40**  
**SKFH 60**  
Thyristor data<sup>1)</sup>



| V <sub>DRM</sub><br>V <sub>RRM</sub> | t <sub>q</sub><br>(T <sub>vj</sub> = 125 °C) | I <sub>TRMS</sub> (maximum values for continuous operation)    |                         |                         |                         |
|--------------------------------------|--|--|-------------------------|-------------------------|-------------------------|
|                                      |  | 110 A  | 130 A                   | 110 A                   | 130 A                   |
| V                                    | μs   | I <sub>TAV</sub> (sin. 180; T <sub>case</sub> = ... °C; 50 Hz) |                         |                         |                         |
|                                      |  | 40 A (87 °C)   | 60 A (81 °C)            | 40 A (87 °C)            | 60 A (81 °C)            |
| 800                                  | 15   | <b>SKFT</b><br>40/08 DS  | <b>SKFT</b><br>60/08 DS | <b>SKFH</b><br>40/08 DS | <b>SKFH</b><br>60/08 DS |
|                                      | 20   | -  | 60/08 DT                | -                       | -                       |
|                                      | 25   | 40/08 DU   | -                       | 40/08 DU                | -                       |
| 1000                                 | 20   | 40/10 DT   | 60/10 DT                | 40/10 DT                | 60/10 DT                |
|                                      | 25   | 40/10 DU   | -                       | 40/10 DU                | -                       |
| 1200                                 | 20   | 40/12 DT   | 60/12 DT                | 40/12 DT                | 60/12 DT                |
|                                      | 25   | 40/12 DU   | 60/12 DU                | 40/12 DU                | 60/12 DU                |
| 1400                                 | 25   | -  | 60/14 DU                | -                       | -                       |

| Symbol  | Conditions   | SKFT 40<br>SKFH 40 <sup>1)</sup>   | SKFT 60<br>SKFH 60 <sup>1)</sup>                 |
|---|--|--|--|
| I <sub>TM</sub>   | sin. 180; T <sub>case</sub> = 60 °C; 500 Hz  | 220 A  | 260 A  |
| I <sub>TSM</sub>  | T <sub>vj</sub> = 25 °C<br>T <sub>vj</sub> = 125 °C  | 1300 A<br>1100 A   | 1500 A<br>1250 A                                 |
| i <sup>2</sup> t  | T <sub>vj</sub> = 25 °C<br>T <sub>vj</sub> = 125 °C  | 8450 A <sup>2</sup> s<br>6060 A <sup>2</sup> s                                 | 11 150 A <sup>2</sup> s<br>7800 A <sup>2</sup> s |
| t <sub>gd</sub><br>t <sub>gr</sub><br>(di/dt) <sub>cr</sub><br>(dv/dt) <sub>cr</sub>      | T <sub>vj</sub> = 25 °C; I <sub>g</sub> = 1 A; di <sub>g</sub> /dt = 1 A/μs<br>V <sub>D</sub> = 0,67 · V <sub>DRM</sub><br>non-repetitive/f = 50 ... 60 Hz<br>T <sub>vj</sub> = 125 °C | 1 μs<br>1 μs<br>600 A/μs / 125 A/μs<br>500 A/μs                                |  |
| I <sub>H</sub><br>I <sub>L</sub>  | T <sub>vj</sub> = 25 °C; typ./max.<br>T <sub>vj</sub> = 25 °C; R <sub>G</sub> = 33 Ω; typ./max.  | 300 mA/600 mA<br>1 A/2 A   |  |
| V <sub>T</sub><br>V <sub>T(TO)</sub><br>r <sub>T</sub><br>I <sub>D</sub> ; I <sub>R</sub> | T <sub>vj</sub> = 125 °C; I <sub>T</sub> = 200 A; max.<br>T <sub>vj</sub> = 125 °C<br>T <sub>vj</sub> = 125 °C<br>T <sub>vj</sub> = 125 °C; V <sub>DRM</sub> ; V <sub>RRM</sub>        | 2,3 V<br>1,5 V<br>4 mΩ<br>15 mA  | 1,75 V<br>1,45 V<br>1,5 mΩ<br>15 mA              |
| V <sub>GT</sub><br>I <sub>GT</sub><br>V <sub>GD</sub><br>I <sub>GD</sub>                  | T <sub>vj</sub> = 25 °C<br>T <sub>vj</sub> = 25 °C<br>T <sub>vj</sub> = 125 °C<br>T <sub>vj</sub> = 125 °C   | 3 V<br>200 mA<br>0,25 V<br>8 mA  |  |
| R <sub>thjc</sub><br>R <sub>thch</sub><br>T <sub>vj</sub><br>T <sub>stg</sub>             | cont. } per thyristor/per module   | 0,43/0,215 °C/W <sup>2)</sup>  | 0,38/0,19 °C/W <sup>2)</sup>                     |
| V <sub>isol</sub><br>M <sub>1</sub><br>M <sub>2</sub><br>w                                | a. c. 50 Hz; r.m.s; 1 s/1 min.<br>Case to heatsink } SI units/<br>Busbars to terminals } US units<br>approx.   | 3000 V ~ /2500 V ~<br>5 Nm/44 lb. in ± 15 %<br>3 Nm/26 lb. in. ± 15 %<br>120 g |  |
| Case  | → page B 2-12  | SKFT<br>A 5<br>A 8   | SKFH<br>A 5<br>A 8                               |



### Features

- Heat transfer through ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. 63 532

### Typical Applications

- Self-commutated inverters
- DC choppers
- AC motor speed control
- Inductive heating
- Uninterruptible power supplies
- Electronic welders
- General power switching applications

<sup>1)</sup> For the data of the diode see page B 2-21

<sup>2)</sup> Internal insulation: beryllium oxide · Observe the warning on page B 2-1.

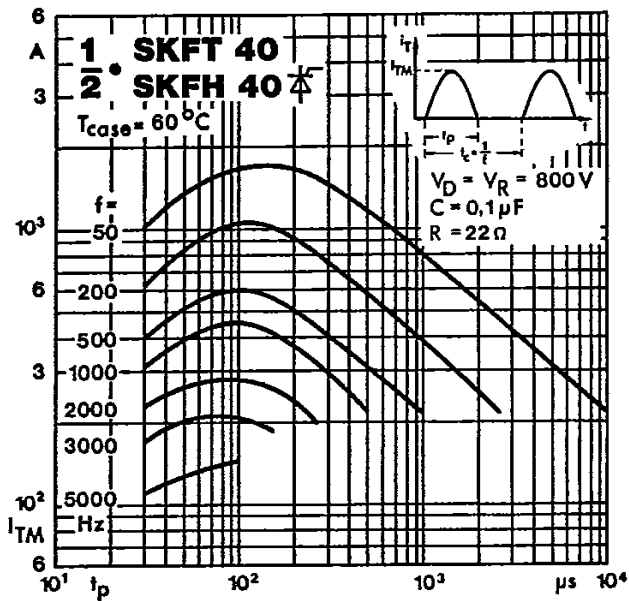


Fig. 1 a Rated peak on-state current vs. pulse duration

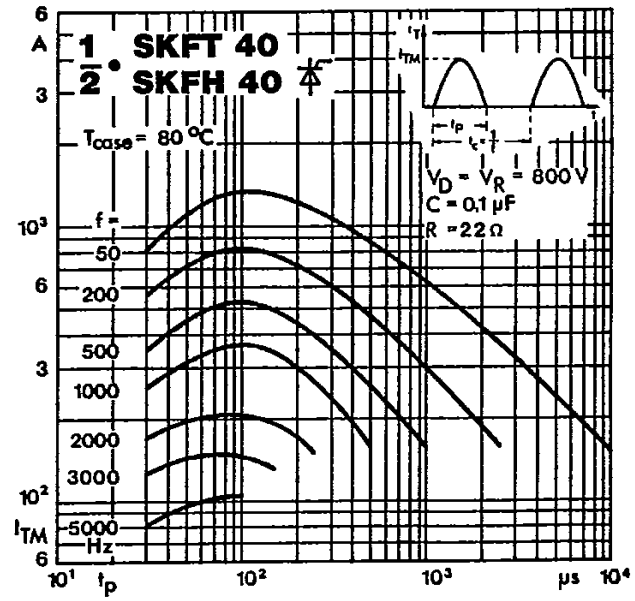


Fig. 1 b Rated peak on-state current vs. pulse duration

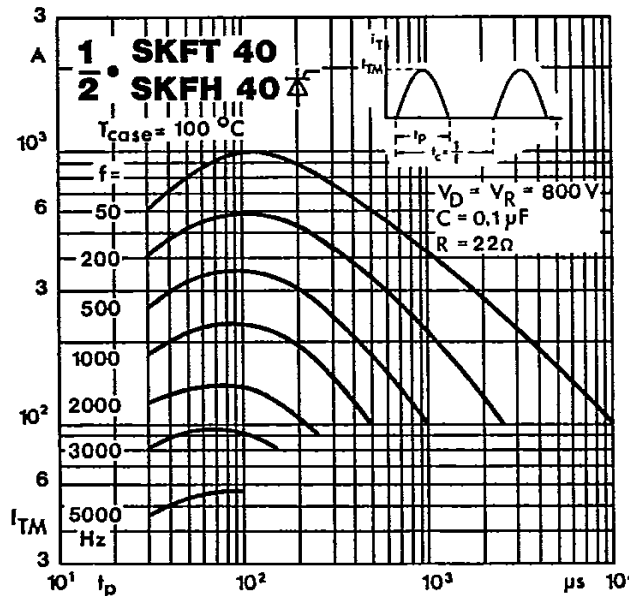


Fig. 1 c Rated peak on-state current vs. pulse duration

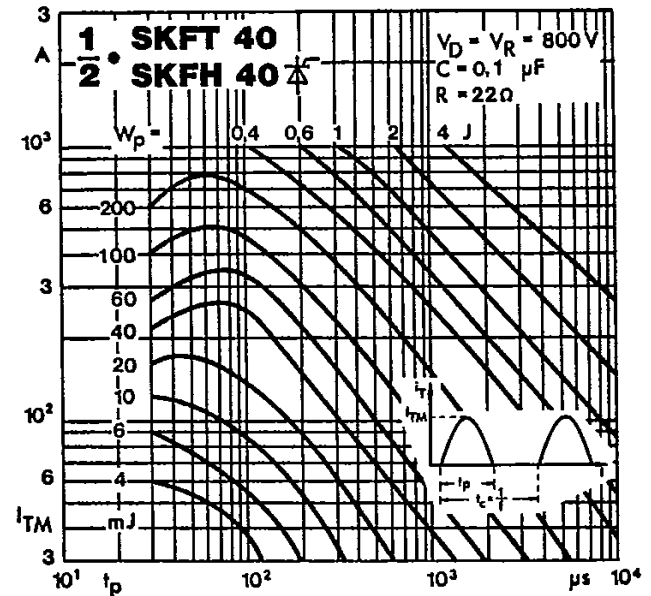


Fig. 2 Energy dissipation per pulse

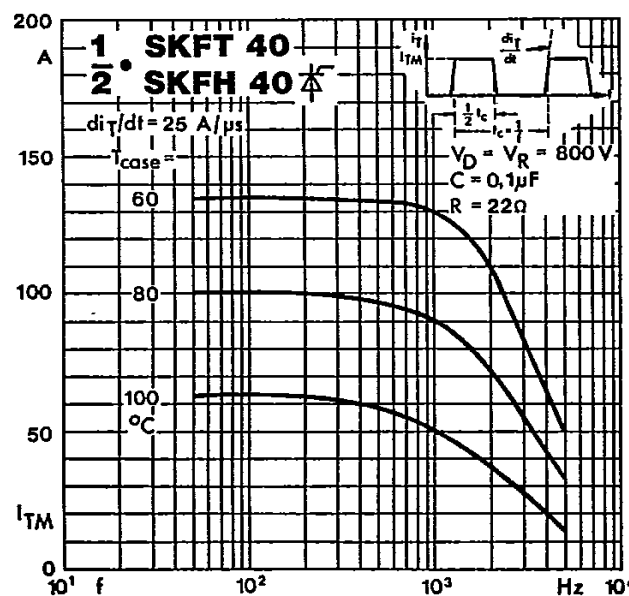


Fig. 3 a Rated peak on-state current vs. pulse duration

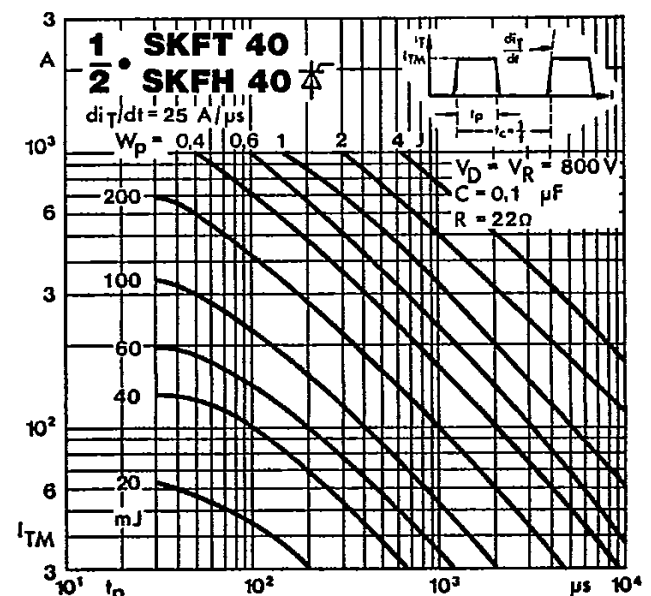


Fig. 4 a Energy dissipation per pulse

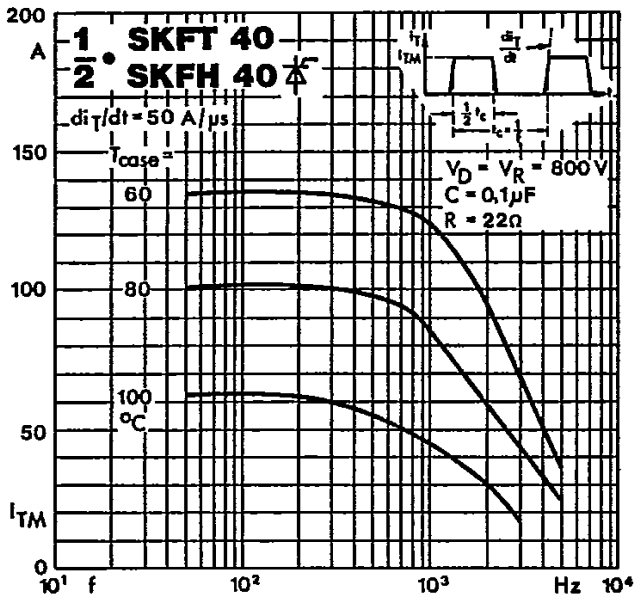


Fig. 3 b Rated peak on-state current vs. pulse duration

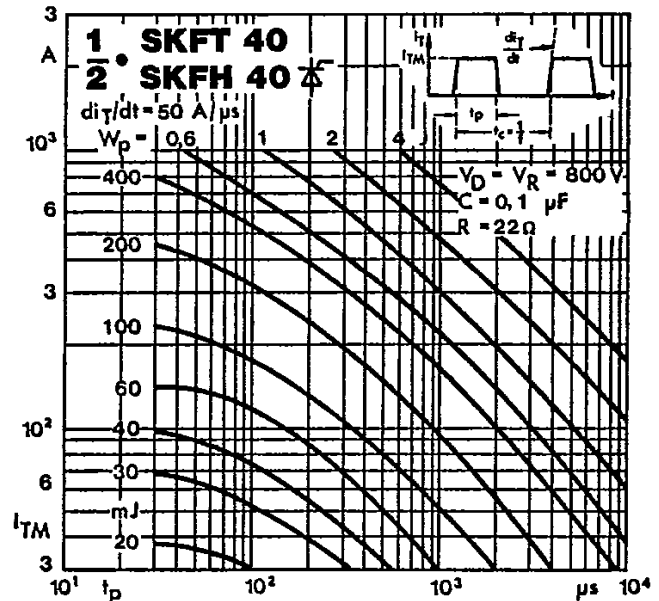


Fig. 4 b Energy dissipation per pulse

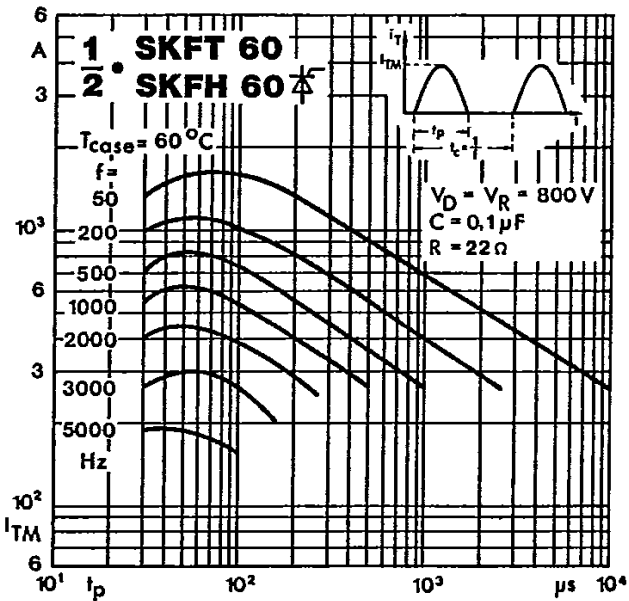


Fig. 1 a Rated peak on-state current vs. pulse duration

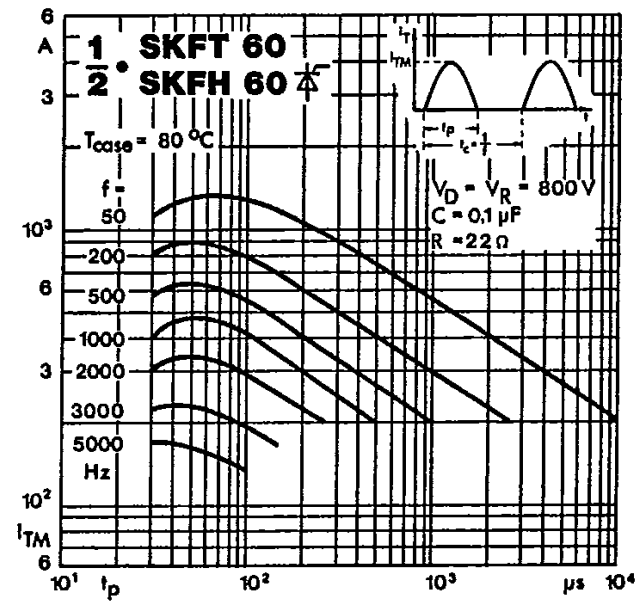


Fig. 1 b Rated peak on-state current vs. pulse duration

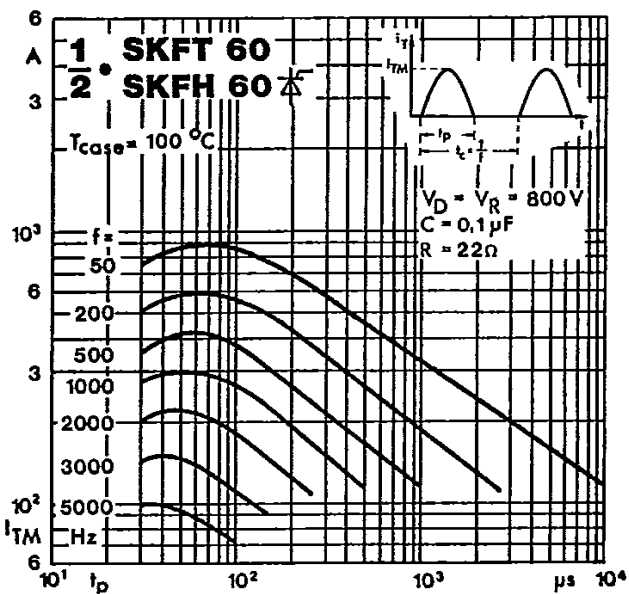


Fig. 1 c Rated peak on-state current vs. pulse duration

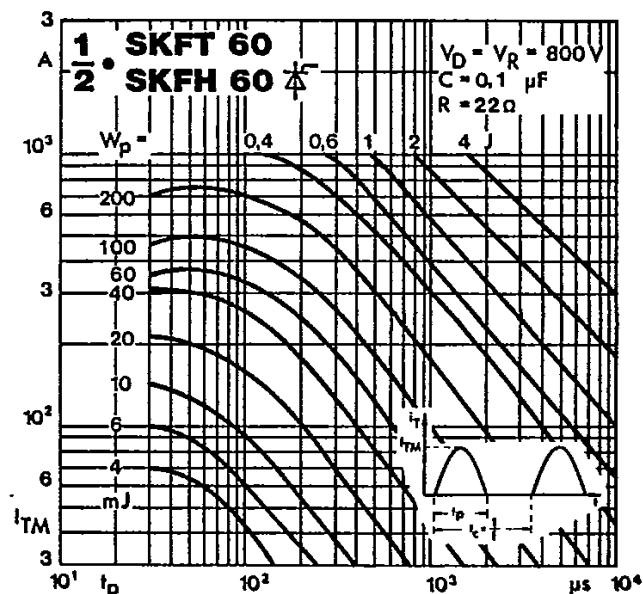


Fig. 2 Energy dissipation per pulse

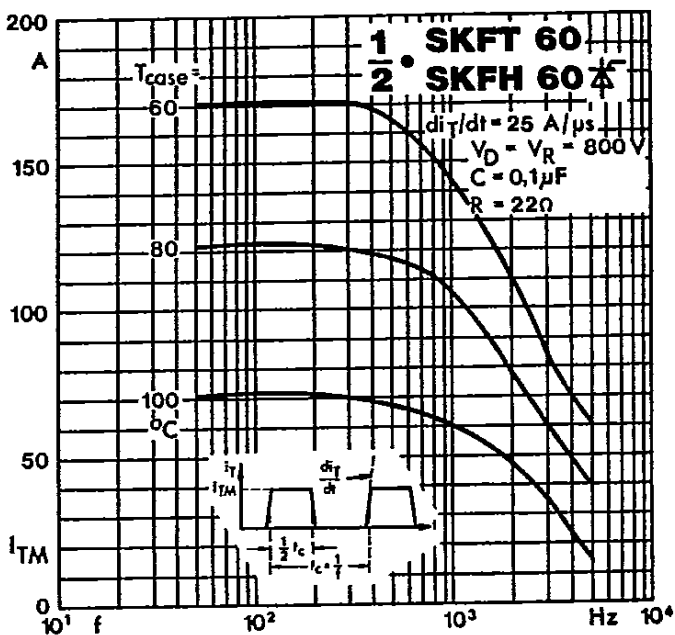


Fig. 3 a Rated peak on-state current vs. pulse duration

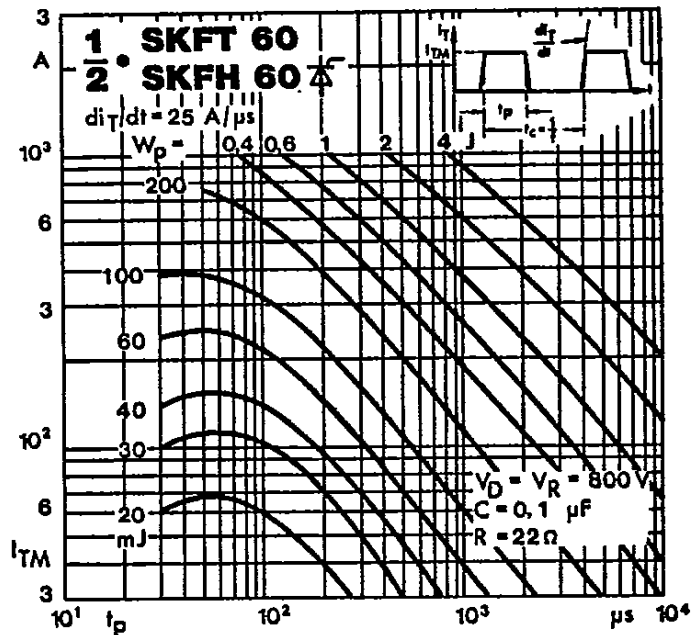


Fig. 4 a Energy dissipation per pulse

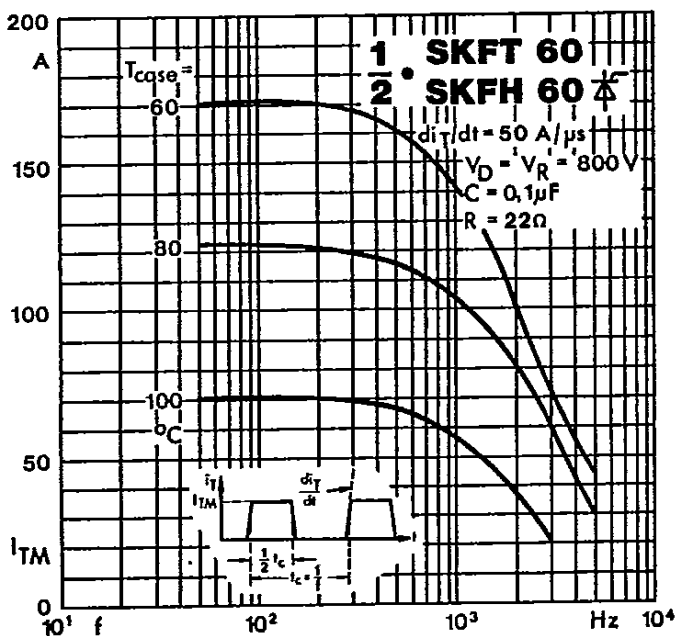


Fig. 3 b Rated peak on-state current vs. pulse duration

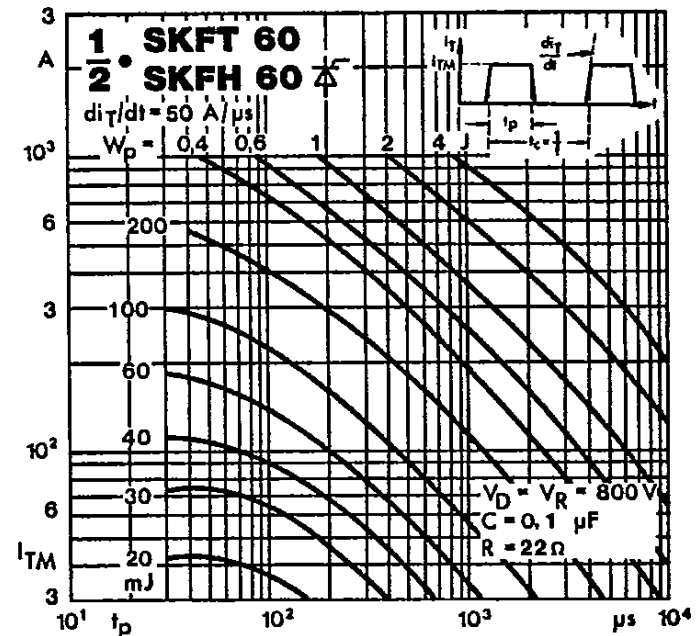


Fig. 4 b Energy dissipation per pulse

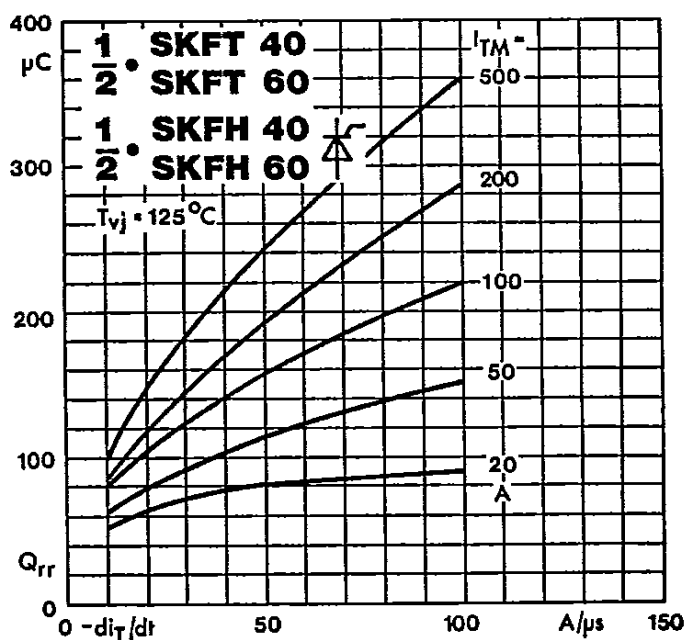


Fig. 5 Recovered charge vs. current decrease

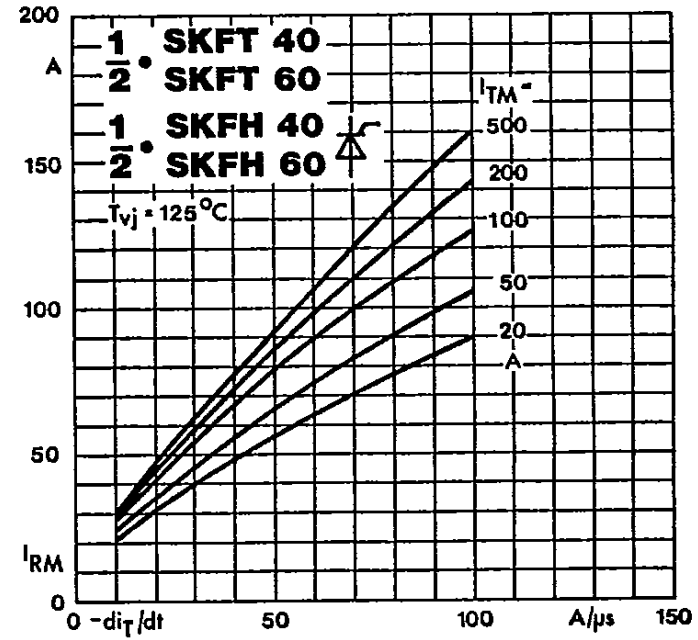


Fig. 6 Peak recovery current vs. current decrease

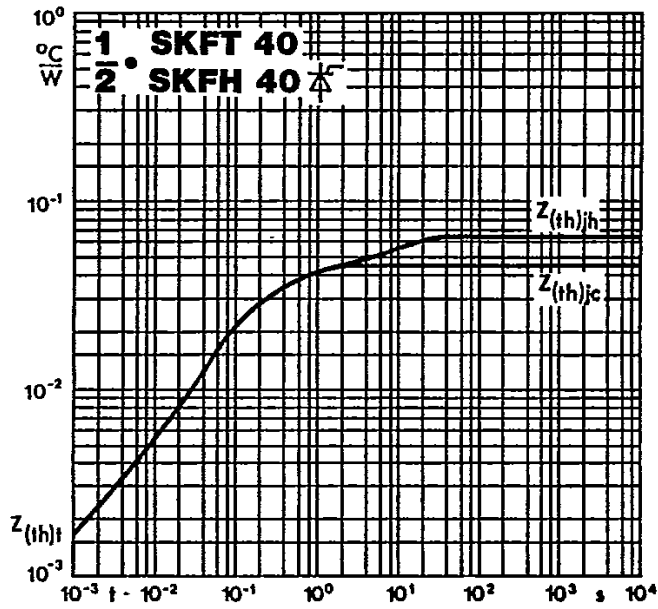


Fig. 7 a Transient thermal impedance vs. time

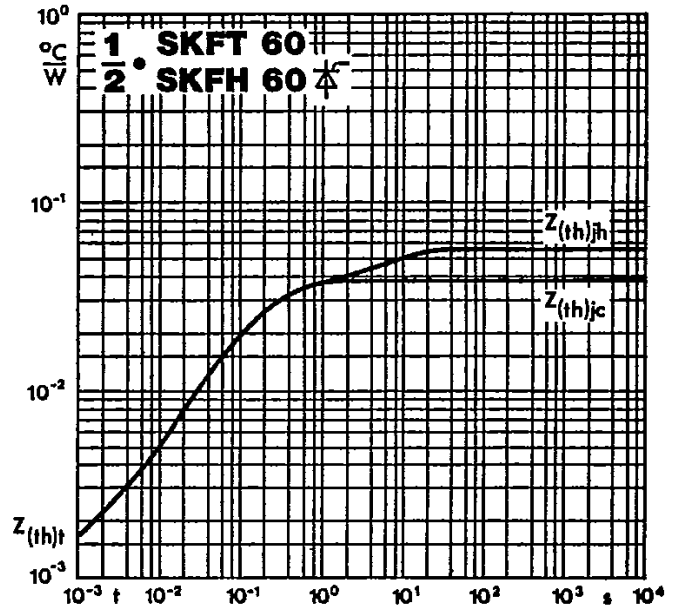


Fig. 7 b Transient thermal impedance vs. time

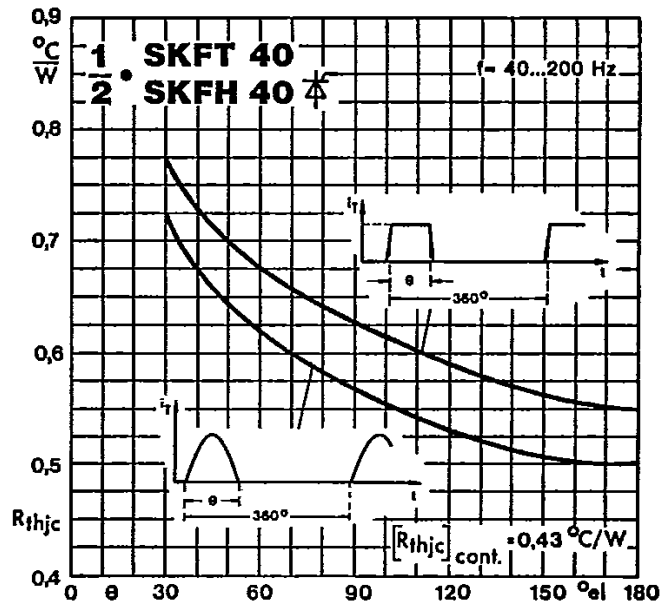


Fig. 8 a Thermal resistance vs. conduction angle, 40...200 Hz

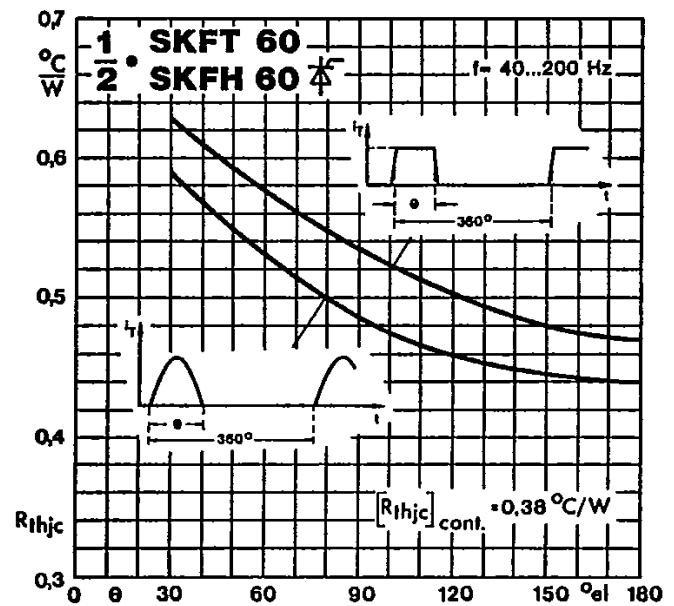


Fig. 8 b Thermal resistance vs. conduction angle, 40...200 Hz

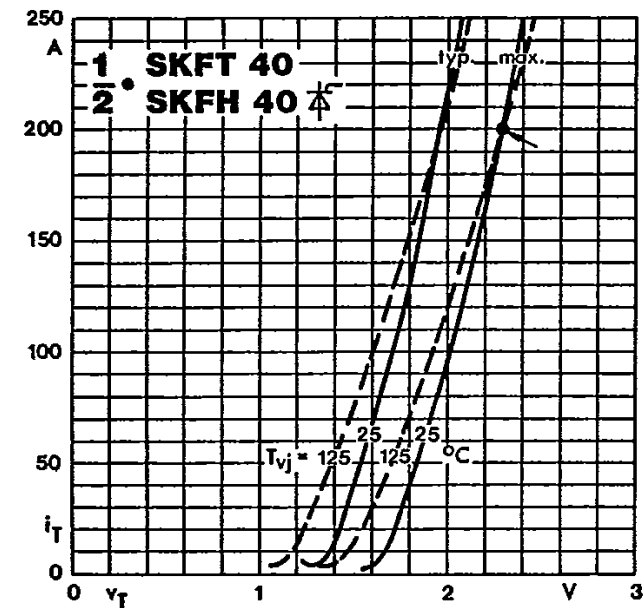


Fig. 9 a On-state characteristics

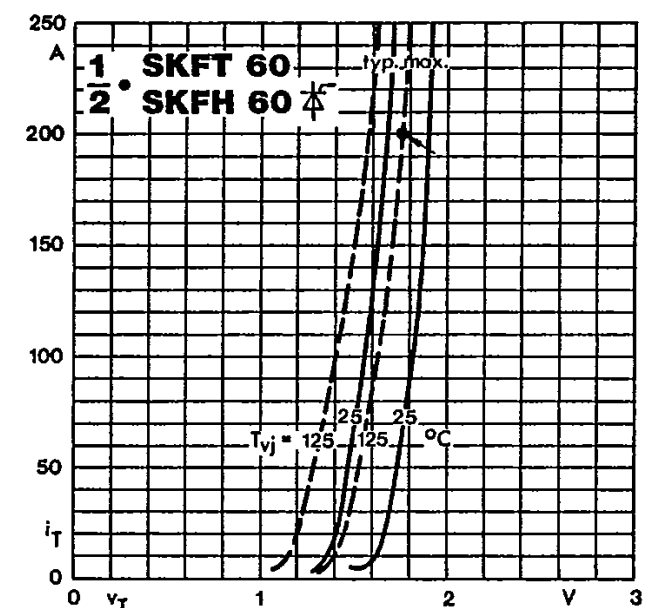


Fig. 9 b On-state characteristics

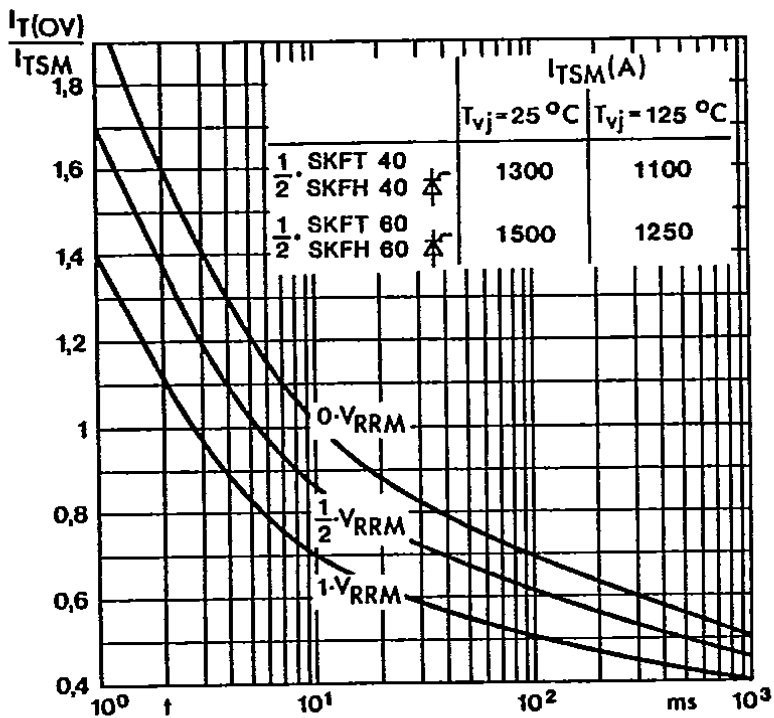


Fig. 10 Surge overload current vs. time

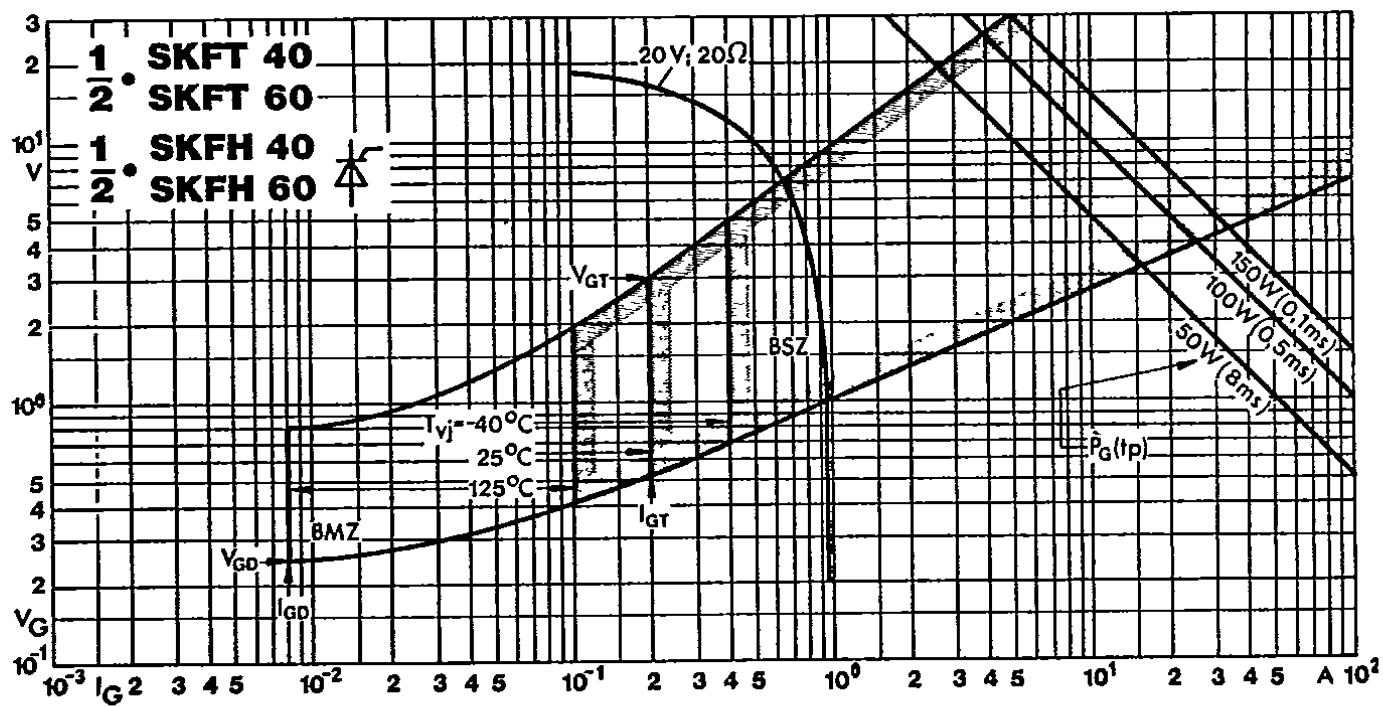


Fig. 11 Gate trigger characteristics